

2 Photodiodes in One Chip for Spacially Resolved Light Detection.

The PR5001 is a dual-element Si photodiode moulded into a small plastic leadless optical package. Produced as one chip, the photodiodes offer a very good symmetry, low dark current and high sensitivity.

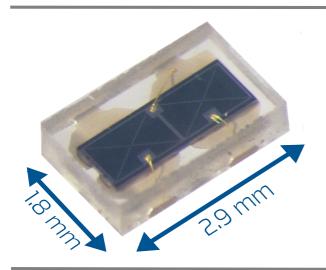
Apart from the standard version **PR5001**, the **PR5001-ARC** features an antireflective layer, smoothing the spectral sensitivity and providing a high good matching from part to part.

FEATURES

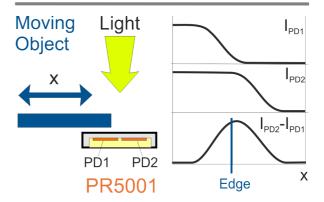
- Low dark current
- Low capacitance
- Good matching between photodiodes

TYPICAL APPLICATIONS

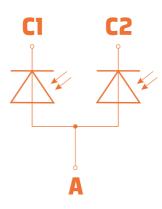
- Laser beam alignment
- Opto encoders
- Position detection



EDGE DETECTOR



CIRCUIT



KEY CHARACTERISTICS

Peak sensitivity 820 nm 0.53 A/Area C1, C2 0.84 mr Dark current Id $T = 27^{\circ}C$ 10 p	Parameter	Conditions	Тур	Units
Area C1, C2 0.84 mr Dark current Id $T = 27^{\circ}C$ 10	and the second second		500 - 1000	nm
Dark current Id $T = 27^{\circ}C$ 10	Peak sensitivity	820 nm	0.53	A/W
	Area	C1, C2	0.84	mm²
Torminal $Vr = 10 V$	Dark current ld	T = 27°C	10	рА
	Terminal capacitance Ct	Vr = 10 V f = 1 MHz	34	рF



Electrical and optical Characteristics

All characteristics apply to both PR5001 and PR5001-ARC, unless noted otherwise.

ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Min	Max	Units
T _A	Operating ambient temperature	-40	85	°C
Ts	Storage temperature	-40	85	°C
T_{peak}	Soldering peak temperature		260	°C
P_{tot}	Total Power Dissipation		100	mW

ELECTRICAL CHARACTERISTICS

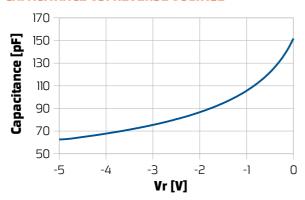
Ta = 27°C, unless otherwise noted.

Symbol	Parameter		Conditions	Min	Тур	Max	Units
V _{r (A-C)}	reverse voltage $V(A) - V(C)$					28	V
A _{PD}	active area (geometrical)	C1, C2	width height inactive area (pads) effective active area		1.145 737 0,05 0.79		mm² hm
l _d	dark current	C1, C2	$V_r = 10V$		10		рА
ΔI _{cl} /ΔT	temperature coefficient of dark current	C1, C2	$V_r = 10V$		10.0		%/K
λ_{peak}	peak sensitivity wavelength	C1, C2			820		nm
S_{peak}	peak sensitivity	C1, C2			0.53		A/W
C_{j0}	zero-bias junction capacitance	C1, C2	$V_r = 0V$, $f = 1 MHz$		125		рF
Cj	biased junction capacitance	C1, C2	$V_r = 10V, f = 1 MHz$		34		рF



Properties and Schematic Assembly

CAPACITANCE VS. REVERSE VOLTAGE



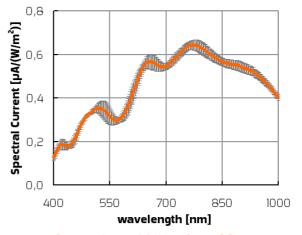
The graph on the left shows the dependency of the terminal capacitance of C1 or C2 vs. the reverse voltage.

SPECTRAL SENSITIVITY

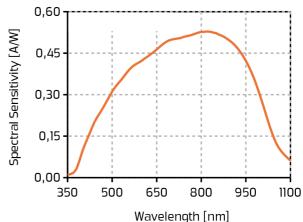
The sensitivity of a single photodiode (size: 0.75 \times 1.2 mm²) is given as a function of wavelength obtained with 0 V forward bias (insignificant changes with voltages up to 10 V). The measurement was conducted with a halogen lamp. A well-known diode was used to calibrate the obtained current to a spectral irradiation density of 1 W/m².

The periodical peaks for **PR5001** can be explained by interference effects within the layers on top of the photodiode. The orange curve illustrates the the average current measured from 10 photodiodes. In gray, the corresponding standard deviation is given. However, from part to part the wavelength corresponding to minima and maxima may vary.

For **PR5001-ARC** these layers are removed, and it features an antireflective layer instead. Therefore there are nearly no interference effects in the wavelength range shown here.



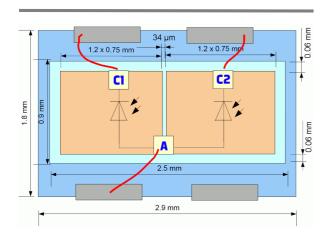
Spectral sensitivity of PR5001 given in μ A/(W/m²) = (A/W) / 0.79



Spectral sensitivity of PR5001-ARC given in A/W = 0.79 · μ A/(W/m²)



DIMENSIONAL OUTLINES AND LAYOUT



PIN DESCRIPTION

Pin No.	Pin Name	PIN Function Description
1	А	Common Anode
2		Not connected
3	C2	Cathode photo diode 2
4	C1	Cathode photo diode 1

= bond wires

= pad area (178 x 192 μm²)

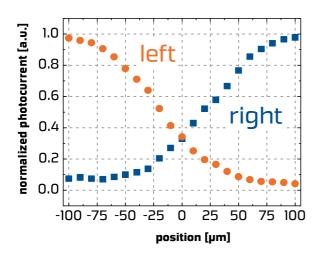
= active area (0.75 x 1.2 mm²)

= die (0.9 x 2.5 mm²)

= clear package (leadless)

Channel separation

WHILE MOVING A BEAM FROM ONE TO THE OTHER PHOTODIODE

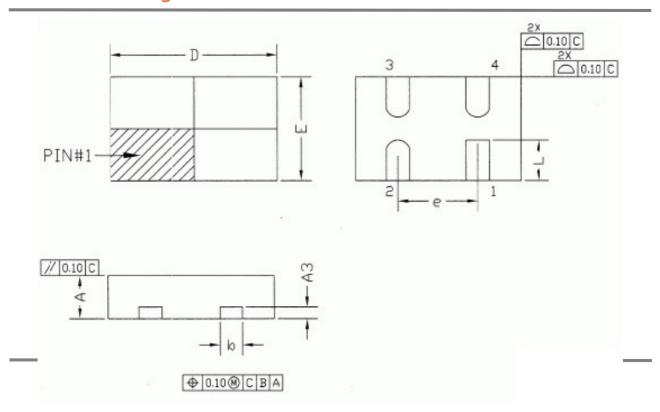


The sensitivity of the crossover between both single photodiodes was measured in detail. To resolve the crossover from one photodiode to the other, increments of 10 μ m were performed using monochromatic light with a wavelength of about 660 nm (red) and a focus point with a diameter of about 100 μ m. 0 μ m correspond to the center of the die. The photocurrent was measured with an applied reverse voltage of about 4 V.

Considering a beam diameter of 100 μ m and a gap between both photodiodes of > 30 μ m (50 μ m between inner of metal rings along the edge of each photodiode), the observed behaviour is consistent with a sharp channel separation.



Available Package



DIMENSIONS

ş							
5 × X 80 L	DIMENSIONS MILLIMETER			DIMENSIONS INCH			
Ľ	MIN.	NDM.	MAX.	MIN.	NDM.	MAX.	
Α	SEE VA			ARIATIONS			
АЗ	0.195 0.203 0.211			0.0077	0.0080	0.0083	
b	0.35	0.40	0.45	0.014	0.016	0.018	
D	2.80	2.90	3.00	0.110	0.114	0.118	
Ε	1.70	1.80	1.90	0.066	0.070	0.074	
6	1.40 BSC.			0.055 BSC.			
L	0.60	0.70	0.80	0.023	0.027	0.031	

	VARIATIONS 'A'							
PAD SIZE	DIMENSIONS MILLIMETER			DIMENSIONS INCH				
	MIN.	NDM.	MAX.	NIN.	NDM.	MAX.		
DFN	0.90	1.00	1.10	0035	0.039	0.043		

NOTES

- 1. DIMENSION AND TOLERANCING CONFORM TO ASME Y14.5M-1994.
 2. CONTROLLING DIMENSIONS : MILLIMITER, CONVERTED INCHDIMENSION ARE NOT NECESSARILY EXACT.
 3. DIMENSION & APPLIES TO METALLIZED TERMINAL AND IS
 MEASURED BETWEEN 0.18 AND 0.30 MM, FROM TERMINAL TIP,
 4. INSULATION THICKNESS OF OVERLAP ARE USER DEFINED.
 5. INSULATION NOT COMPLETELY SHOWN FOR REASONS OF CLARITY,



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